

SPECIFICATION

Ceramic Antenna 3216 Size

2400-2500 MHz

P/N: HXD-BT6-HML2

地址 : 龙华大浪华达路辉煌综合楼

Address: Room 306, Huichuang Comprehensive
Building, Huada Road, Dalang, Longhua District, Shenzhen, China

1. Frequency

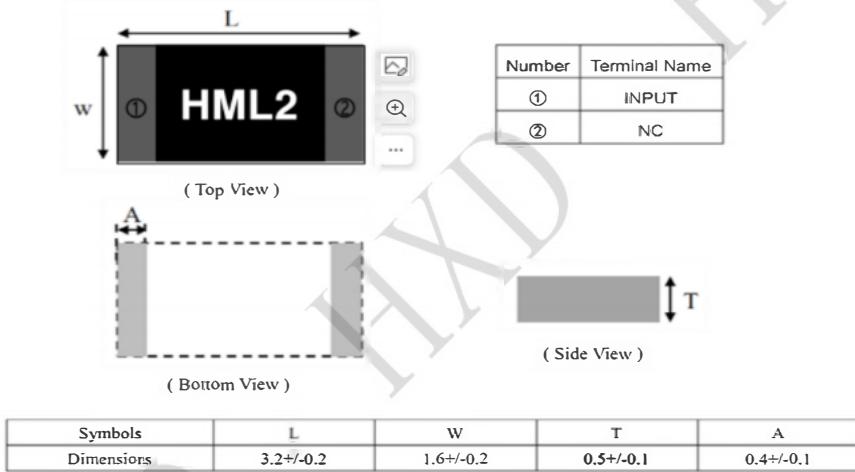
2400-2500 MHz

2. Applications

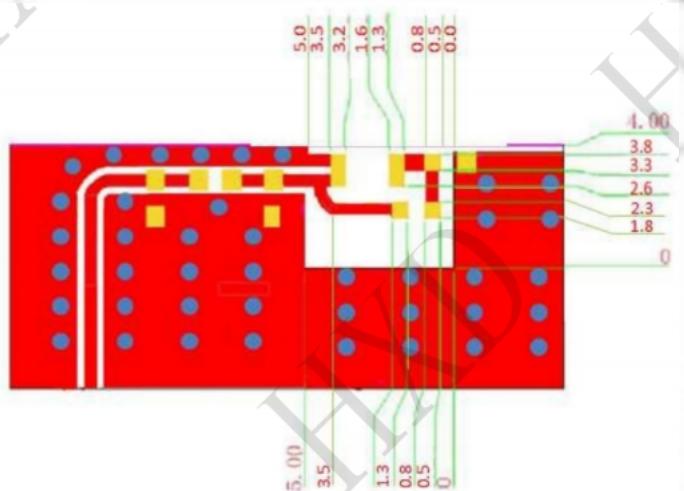
For Miniaturized Bluetooth System

3. Dimensions (Unit : mm)

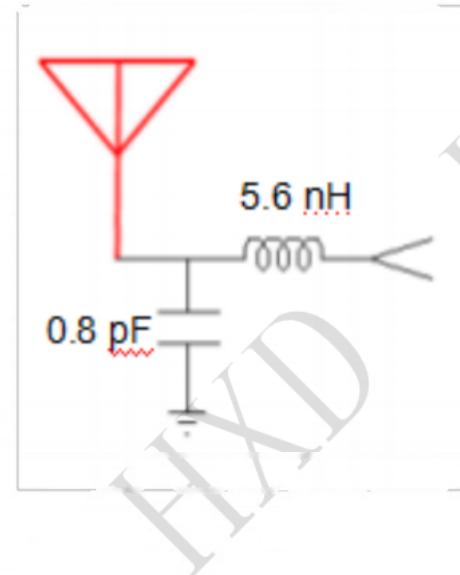
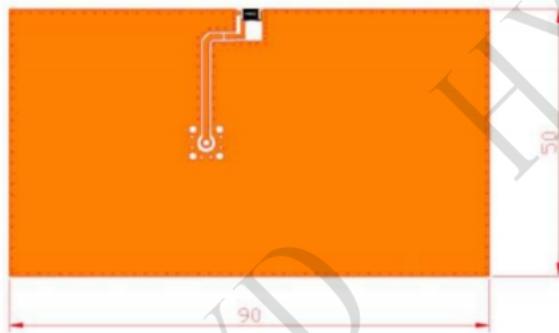
1). Over View :



2). PCB Layout (Unit : mm) :



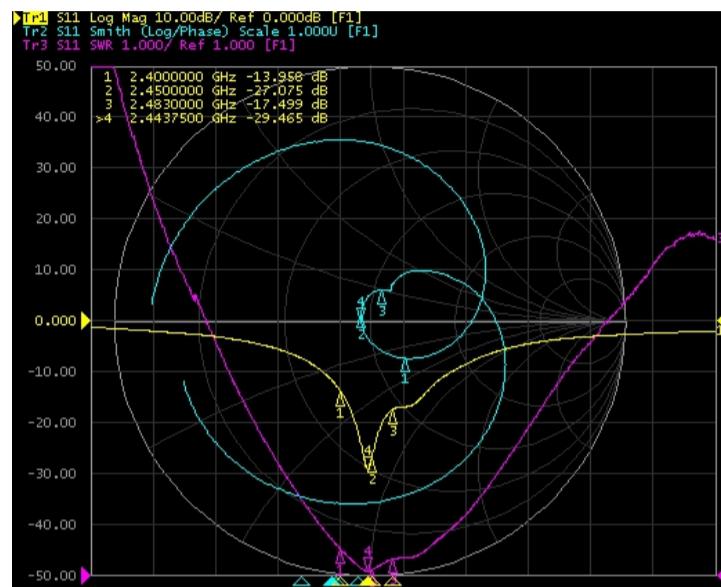
4. Evaluation Board Size and Matching Circuits



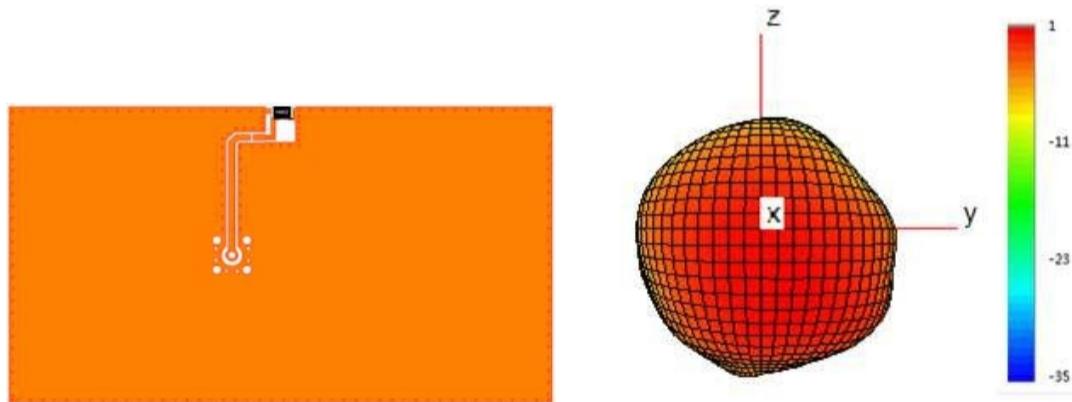
5. Electrical Characteristics

Part Number	HXD-BT6-HML2
Central Frequency	2450 MHz
Bandwidth	100(typ.) MHz
V.S.W.R	≤ 2.0
Peak Gain	3.12 dBi
Impedance	50 Ohm
Polarization	Linear
Azimuth Beamwidth	Omni-directional

6. Return Loss (S11)

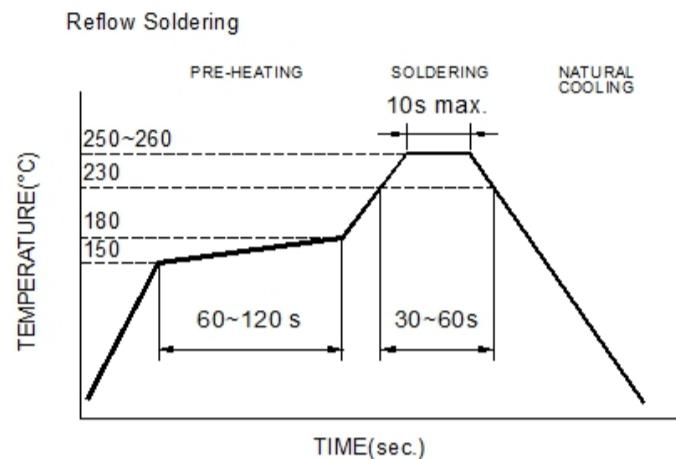


7. Radiation Pattern & Efficiency



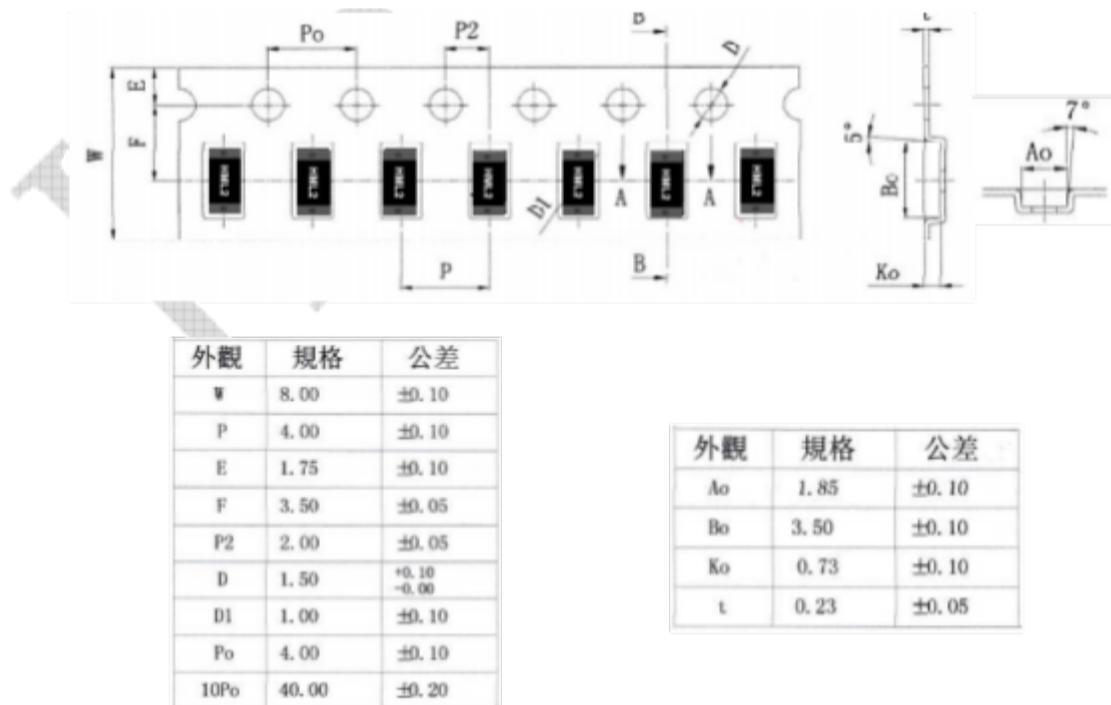
Frequency (MHz)	2400	2450	2500
Efficiency (dB)	-2.22	-1.87	-2.08
Efficiency (%)	60	65	62
Gain (dBi)	2.75	3.12	3.01

8. Reflow Soldering Standard Condition



9. Packaging and Dimensions

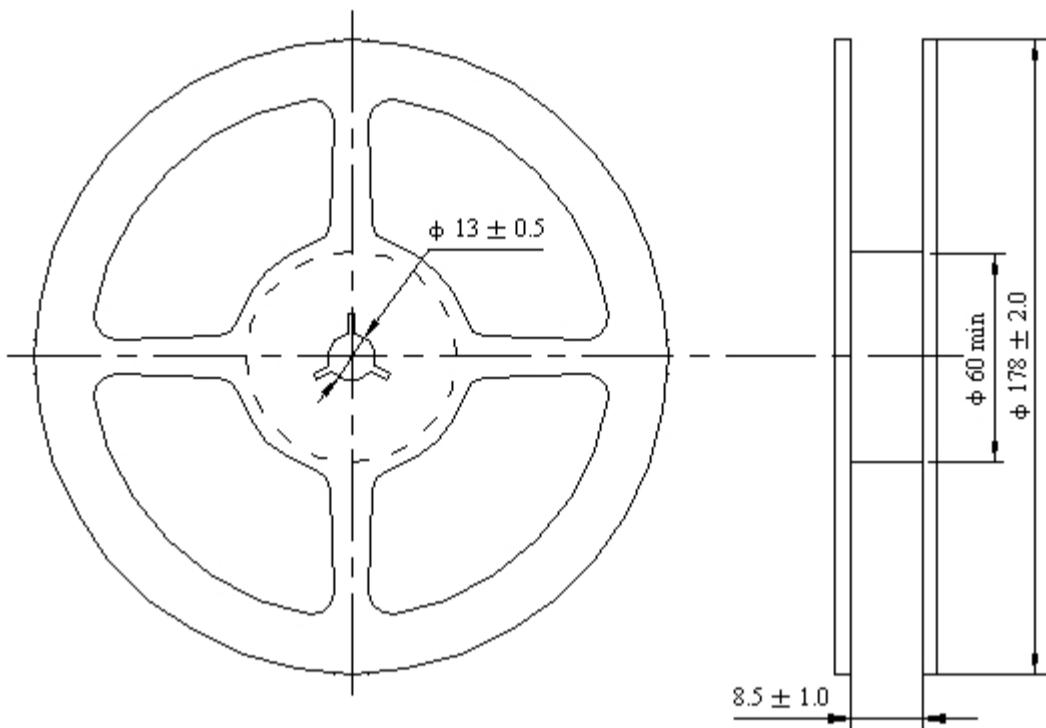
- Plastic Tape



- **Remarks for Package**

Reserve a length of 150~200mm for the trailer of the carrier and 250~300 mm for the leader of the carrier and further 250mm of cover tape at the leading part of the carrier.

- **Reel (4000 pcs/Reel)**



Storage Period

Oxidizable Material, 12 months in vacuum sealed bag, please repack within 168 hours by re-seal the package treatment after using.

Storage Temperature Range : <30 degree C, Humidity : <60%RH

10. Dependability Test

Test item	Test condition / Test method	Specification
Solderability IEC 60068-2-58 GB/T2423.28	*Solder bath temperature : 240±5°C *Immersion time : 2±0.5 sec Solder : Sn96.5Ag3.0Gu0.5 for lead-free.	At least 95% of a surface of each terminal electrode must be covered by fresh solder.
Leaching (Resistance to dissolution of metallization) JIS C5101	*Solder bath temperature : 260±5°C *Leaching immersion time : 10±1 sec Solder : Sn96.5 Ag3.0 Gu0.5 for lead-free.	Loss of metallization on the edges of each electrode shall not exceed 25%.
Resistance to soldering heat IEC 60068-2-58 GB/T2423.28	*Preheating temperature : 120~150°C, 1 minute. *Solder temperature : 260±5°C *Immersion time : 10±1 sec Solder : Sn96.5Ag3.0Gu0.5 for lead-free Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature. Loss of metallization on the edges of each electrode shall not exceed 25%.
Drop Test IEC 60068-2-32 GB/T2423.8 Customer' s specification.	*Height : 50 cm *Test Surface: Rigid surface of concrete or steel. *Times : 6 surfaces for each units ; 2 times for each side.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Vibration IEC 60068-2-6 GB/T 2423.10	*Frequency : 10Hz~55Hz~10Hz(1min) *Total amplitude : 1.5mm *Test times : 6hrs.(Two hrs each in three mutually perpendicular directions)	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Adhesive Strength of Termination IEC60068-2-21 GB/T 2423.6	*Pressurizing force : 5N(\leq 0603) ; 10N(>0603) *Test time:10±1 sec	No remarkable damage or removal of the termination.

Bending test IEC 60068-2-21 GB/T 2423.29	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 2mm and then pressure shall be maintained for 10 ± 1 sec. Measurement to be made after keeping at room temperature for 24 ± 2 hours.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Temperature cycle IEC60068-2-14 GB/T 2423.22	30 minutes at $-40^{\circ}\text{C}\pm 2^{\circ}\text{C}$. 10~15 minutes at room temperature. 30minutes at $+85^{\circ}\text{C}\pm 2^{\circ}\text{C}$. 10~15 minutes at room temperature. Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24 ± 2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
High temperature IEC 60068-2-2 GB/T2423.2	*Temperature : $85\pm 2^{\circ}\text{C}$. *Test duration : $500+24/-0$ hours. Measurement to be made after keeping at room temperature for 24 ± 2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics.
Humidity (steady conditions) IEC60068-2-3 GB/T 2423.3	*Humidity : $85\pm 5\%$ R.H. *Temperature : $85\pm 2^{\circ}\text{C}$. *Time : $500+24/-0$ hrs. Measurement to be made after keeping at room temperature for 24 ± 2 hrs ※ 200hrs measuring the first data then 300hrs data.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Low temperature IEC 60068-2-1 GB/T2423.1	*Temperature : $-40\pm 2^{\circ}\text{C}$. *Test duration : $500+24/-0$ hours Measurement to be made after keeping at room temperature for 24 ± 2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.